

Lonten N-channel 600V, 12A Power MOSFET

Description

The Power MOSFET is fabricated using the advanced planer VDMOS technology. The resulting device has low conduction resistance, superior switching performance and high avalance energy.

Features

- ◆ Low R_{DS(on)}
- Low gate charge (typ. Q_g = 40.8 nC)
- ◆ 100% UIS tested
- RoHS compliant

Applications

- Power factor correction.
- Switched mode power supplies.
- LED driver.

Product Summary				
V_{DSS}	600V			
I_D	12A			
$R_{\text{DS(on)},\text{max}}$	0.759	Ω		
$Q_{g,typ}$	40.8	nC		
GD'S	Can's	Constant of the second	Company of the control of the contro	
TO-262	TO-263	TO-220	TO-220F	
	G H	S MOSFET	Po	

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	600	V
Continuous drain current (T _C = 25°C)	I _D	12	A
(T _C = 100°C)		7.5	Α
Pulsed drain current 1)	I _{DM}	48	A
Gate-Source voltage	V _{GSS}	±30	V
Avalanche energy, single pulse 2)	E _{AS}	605	mJ
Peak diode recovery dv/dt 3)	dv/dt	5	V/ns
Power Dissipation TO-220F (T _C = 25°C)		42	W
Derate above 25°C		0.34	W/°C
Power Dissipation	P _D		
TO-220\ TO-262\ TO-263 (T _C = 25°C)		150	W
Derate above 25°C		1.2	W/°C
Operating juncition and storage temperature range	T _J , T _{STG}	-55 to +150	°C
Continuous diode forward current	Is	12	Α
Diode pulse current	I _{S,pulse}	48	Α

Thermal Characteristics

Devementer	Cumbal	Value		11-:4	
Parameter	Symbol	TO-220F	TO-220\TO-251\TO-252	Unit	
Thermal resistance, Junction-to-case	R _{eJC}	2.98	0.83	°C/W	
Thermal resistance, Junction-to-ambient	$R_{\theta JA}$	110	62.5	°C/W	

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Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LNC12N60	TO-220	LNC12N60	50	
LND12N60	TO-220F	LND12N60	50	
LNE12N60	TO-263	LNE12N60	50	
LNF12N60	TO-262	LNF12N60	50	

Electrical Characteristics T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	•		•	•	•	•
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =0.25 mA	2	-	4	V
Drain cut-off current	I _{DSS}	V _{DS} =600 V, V _{GS} =0 V,				
		$T_j = 25$ °C	-	-	1	μΑ
		T _j = 125°C	-		100	
Gate leakage current, Forward	I _{GSSF}	V _{GS} =30 V, V _{DS} =0 V	-	-	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-30 V, V _{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =6A	-	0.53	0.75	Ω
Dynamic characteristics						•
Input capacitance	C _{iss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	-	1960	-	
Output capacitance	Coss	f = 1 MHz	-	163	-	pF
Reverse transfer capacitance	C _{rss}]	-	7.2	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 300 V, I _D = 12 A	-	14.3	-	
Rise time	t _r	$R_G = 10 \Omega, V_{GS} = 15 V$	-	37.6	-	ns
Turn-off delay time	t _{d(off)}		-	65.4	-	
Fall time	t _f		-	14.2	-	
Gate charge characteristics	•		•	•	•	
Gate to source charge	Q_{gs}	V _{DD} =480 V, I _D =12 A,	-	11.0	-	
Gate to drain charge	Q_{gd}	V _{GS} =0 to 10 V	-	15.6	-	nC
Gate charge total	Q_g		-	40.8	-	
Gate plateau voltage	V _{plateau}]	-	5	-	V
Reverse diode characteristics			•			•
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =12 A	-	-	1.5	V
Reverse recovery time	t _{rr}	V _R =300 V, I _F =12 A,	-	387.2	-	ns
Reverse recovery charge	Q _{rr}	dI _F /dt=100 A/µs	-	3.87	-	μC
Peak reverse recovery current	I _{rrm}]	-	20.3	-	Α

Notes:

- 1. Pulse width limited by maximum junction temperature.
- 2. L=10mH, I_{AS} = 11A, Starting T_j = 25°C.
- 3. I_{SD} = 12A, di/dt \leqslant 100A/us, V_{DD} \leqslant B V_{DS} , Starting T_j = 25°C.

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Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

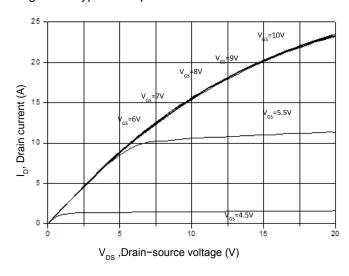


Figure 3. On-Resistance Variation vs. Drain Current

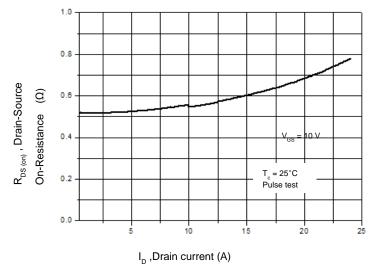


Figure 5. Breakdown Voltage vs. Temperature

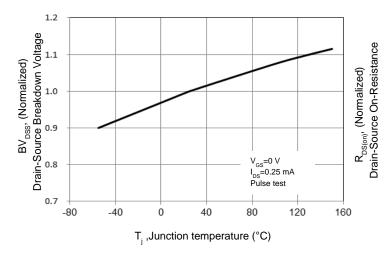


Figure 2. Transfer Characteristics

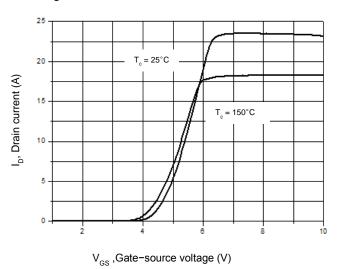


Figure 4. Threshold Voltage vs. Temperature

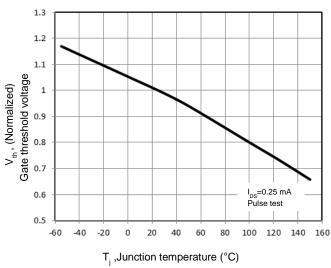
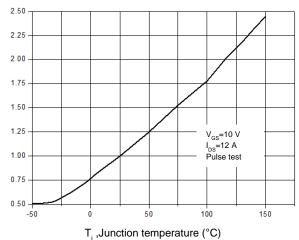


Figure 6. On-Resistance vs. Temperature



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Figure 7. Capacitance Characteristics

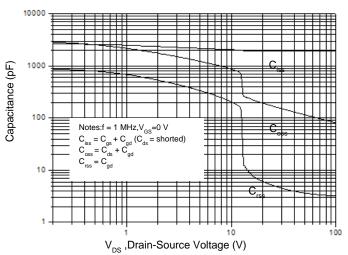


Figure 9. Maximum Safe Operating Area

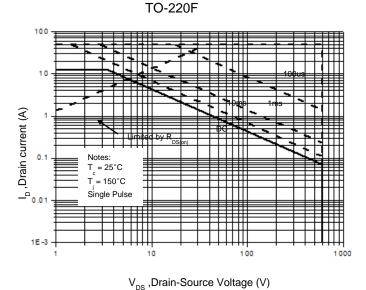


Figure 11. Power Dissipation vs. Temperature

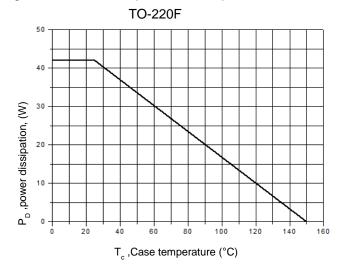
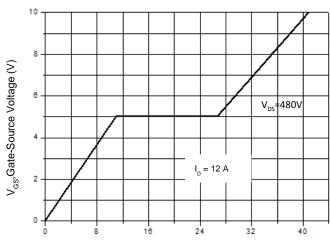
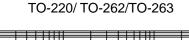


Figure 8. Gate Charge Characterist



Q_c ,Total Gate Charge (nC)
Figure 10. Maximum Safe Operating Area
TO-220/TO-263/TO-263



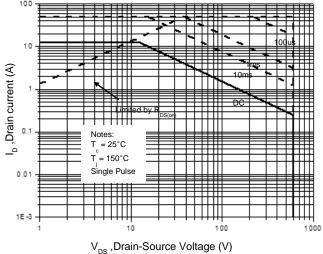
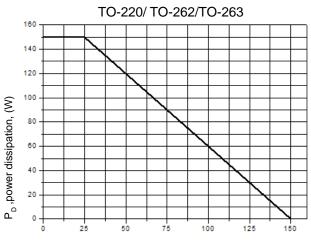


Figure 12. Power Dissipation vs. Temperature



T_c ,Case temperature (°C)



Figure 13. Continuous Drain Current vs. Temperature

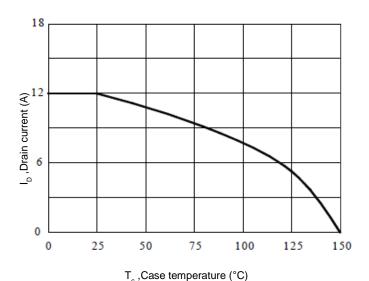


Figure 14. Body Diode Transfer Characteristics

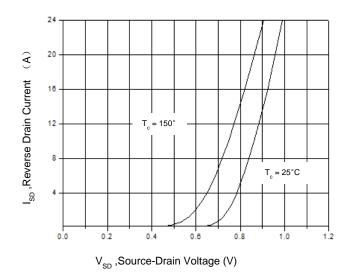


Figure 15 Transient Thermal Impendance, Junction to Case, TO-220F

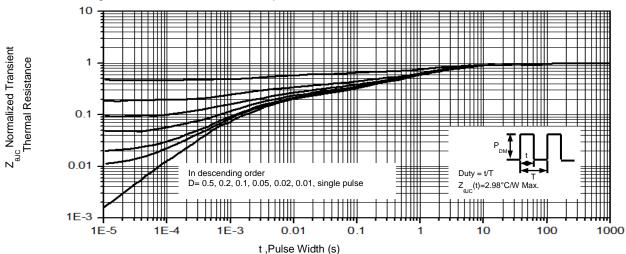
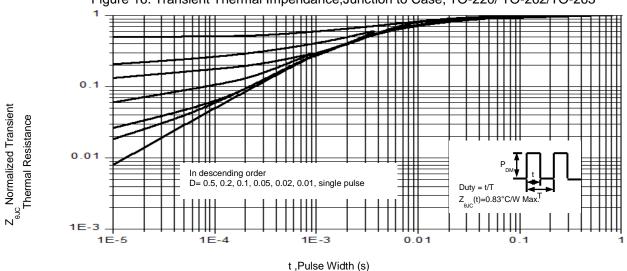


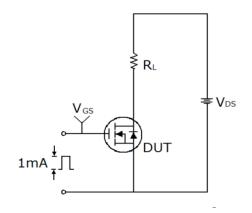
Figure 16. Transient Thermal Impendance, Junction to Case, TO-220/TO-263/TO-263

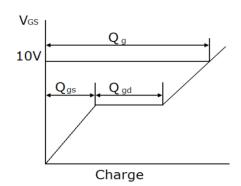


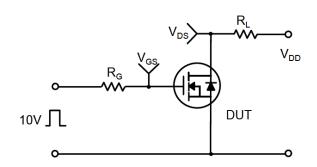
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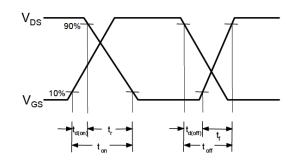


Gate Charge Test Circuit & Waveform

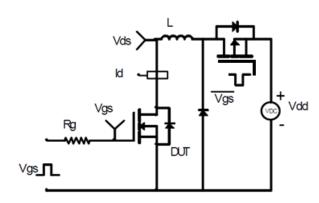


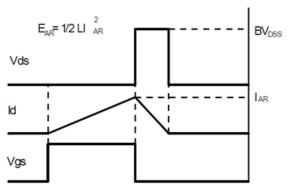






Unclamped Inductive Switching Test Circuit & Waveforms



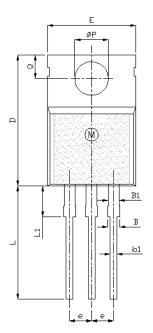


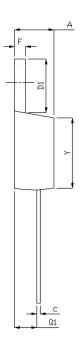
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UNIT: mm



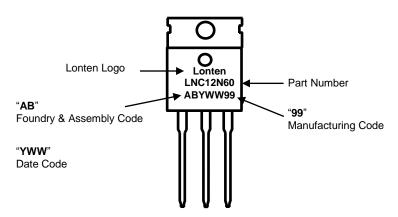
Mechanical Dimensions for TO-220





SYMBOL	MIN	NOM	MAX
Α	4		4.8
В	1.2		1.4
B1	1		1.4
b1	0.75		0.95
С	0.4		0.55
D	15		16.5
D1	5.9		6.9
E	9.9		10.7
е	2.44	2.54	2.64
F	1.1		1.4
L	12.5		14.5
L1	3	3.5	4
ФР	3.7	3.8	3.9
Q	2.5		3
Q1	2		2.9
Y	8.02	8.12	8.22

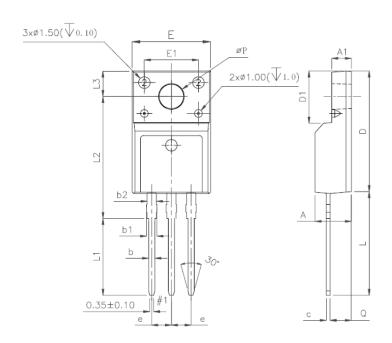
TO-220 Part Marking Information



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Mechanical Dimensions for TO-220F

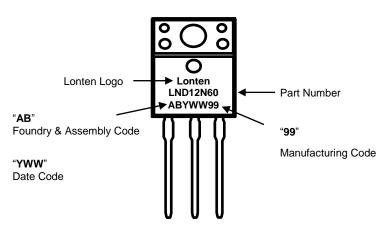


		UNIT: mm		
SYMBOL	MIN	NOM	MAX	
Α	4.5		4.9	
A1	2.3		2.9	
b	0.65		0.9	
b1	1.1		1.7	
b2	1.2		1.4	
С	0.35		0.65	
D	14.5		16.5	
D1	6.1		6.9	
E	9.6		10.3	
E1	6.5	7	7.5	
е	2.44	2.54	2.64	
L	12.5		14.3	
L1	9.45		10.05	
L2	15		16	
L3	3.2		4.4	
ФР	3		3.3	

2.5

2.9

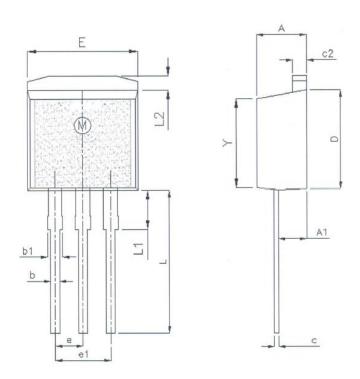
TO-220F Part Marking Information



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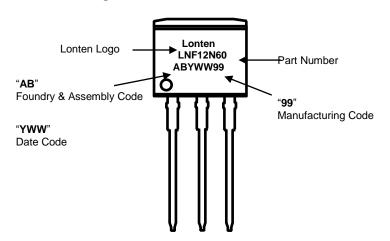
Mechanical Dimensions for TO-262



SYMBOL MIN NOM MAX 4.42 4.72 Α1 2.40 2.80 b 0.76 0.86 b1 1.22 1.40 С 0.33 0.43 c2 1.22 1.35 D 8.99 9.29 е 2.44 2.54 2.64 e1 4.98 5.18 Е 9.95 10.25 L 12.50 13.60 L1 3.30 3.50 3.80 L2 1.22 1.40 Υ 8.02 8.12 8.22

UNIT: mm

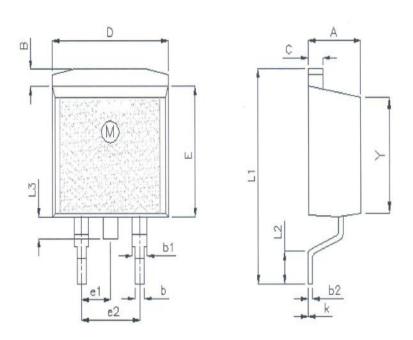
TO-262 Part Marking Information



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Mechanical Dimensions for TO-263



SYMBOL MIN NOM MAX 4.42 4.72 В 1.22 1.4 b 0.76 0.86 b1 1.22 1.4 b2 0.33 0.43 С 1.22 1.35 D 9.95 10.25 Ε 8.99 9.29 2.44 2.54 2.64 e2 4.98 5.18 L1 14.7 15.1 15.5 L2 2 2.3 2.6 L3 1.5 2

-0.1

8.02

Κ

Υ

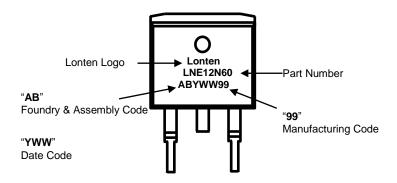
UNIT: mm

0.1

8.22

8.12

TO-263 Part Marking Information



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